

Z0410xE/F

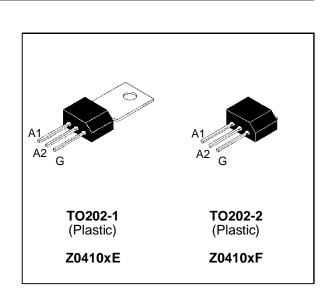
STANDARD TRIACS

FEATURES

- $I_{T(RMS)} = 4A$
- $V_{DRM} = 400 \text{V to } 800 \text{V}$
- $I_{GT} \le 25mA$

DESCRIPTION

The Z0410xE/F series of triacs uses a high performance TOP GLASS PNPN technology. These parts are intended for general purpose switching and phase control applications.



ABSOLUTE RATINGS (limiting values)

Symbol	Parame	Value	Unit		
I _{T(RMS)}	RMS on-state current	Z0410xE/F	Tc= 75 °C	4	Α
	(360° conduction angle)	Z0410xF	Ta= 25 °C	0.95	
I _{TSM}	Non repetitive surge peak on-st	tp = 8.3 ms	22	Α	
	$(T_j \text{ initial} = 25^{\circ}\text{C})$	tp = 10 ms	20		
l ² t	I ² t Value for fusing	tp = 10 ms	2	A ² s	
dI/dt	Critical rate of rise of on-state c I _G = 50 mA dig/dt = 0.1 A/µ	Repetitive F = 50 Hz	10	A/μs	
		Non Repetitive	50		
T _{stg} T _j	Storage and operating junction temperature range			- 40, + 150 - 40, + 125	°C
TI	Maximum lead temperature for soldering during 10s at 4.5mm from case			260	°C

Symbol	Parameter		Voltage			
			М	S	N	Unit
VDRM VRRM	Repetitive peak off-state voltage T _j = 125°C	400	600	700	800	٧

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Z0410xE/F

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit	
Rth(j-a)	Junction to ambient Z0410xE		80	°C/W
		Z0410xF	100	
Rth(j-c)	Junction to case for D.C	10	°C/W	
Rth(j-c)	Junction to case for A.C 360° conduction and	7.5	°C/W	

GATE CHARACTERISTICS (maximum values)

 $P_{G (AV)}$ = 0.2 W P_{GM} = 3 W (tp = 20 μ s) I_{GM} = 1.2 A (tp = 20 μ s)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrant		Sensitivity	Unit	
Symbol	rest conditions	Quadrant		10		
I _{GT}	$V_D=12V$ (DC) $R_L=33\Omega$ $Tj=25^{\circ}C$		I-II-III-IV	MAX	25	mA
V_{GT}	$V_D=12V$ (DC) $R_L=33\Omega$	Tj= 25°C	I-II-III-IV	MAX	1.5	V
V_{GD}	$V_D=V_{DRM}$ $R_L=3.3k\Omega$	Tj= 125°C	I-II-III-IV	MIN	0.2	V
tgt	$\begin{array}{ll} V_D {=} V_{DRM} & I_G = 40 \text{mA} \\ I_T = 5.5 \text{A} \\ dI_G {/} dt = 0.5 \text{A} {/} \mu \text{s} \end{array}$	Tj= 25°C	I-II-III-IV	TYP	2	μs
I _H *	I _T = 50 mA Gate open	Tj= 25°C		MAX	25	mA
IL	I _G = 1.2 I _{GT}	Tj= 25°C	I-III-IV	TYP	25	mA
			Ш	TYP	50	
V _{TM} *	I _{TM} = 5.5A tp= 380μs	Tj= 25°C		MAX	2	V
IDRM	VD = VDRM	Tj= 25°C		MAX	5	μΑ
I _{RRM}	$V_R = V_{RRM}$	Tj= 110°C		MAX	200	
dV/dt *	DI WI			MIN	200	V/μs
	Gate open			TYP	400	
(dV/dt)c*	(dl/dt)c = 1.8 A/ms	Tj= 110°C		MIN	5	V/μs

 $^{^{\}star}$ For either polarity of electrode A_2 voltage with reference to electrode A_1

ORDERING INFORMATION

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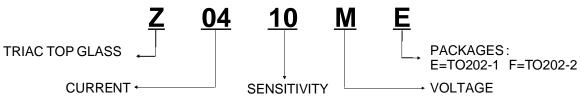
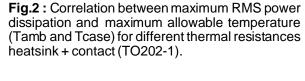


Fig.1: Maximum RMS power dissipation versus RMS on-state current.



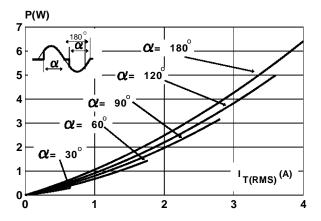


Fig.3: Maximum RMS power dissipation versus RMS on-state current.

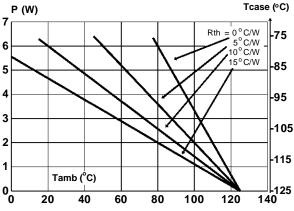


Fig.4: Correlation between maximum RMS power dissipation and maximum allowable temperature (Tamb and Tcase) (TO202-2).

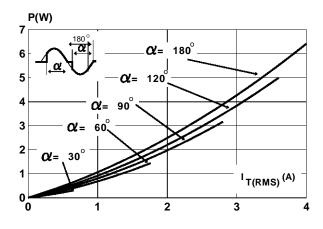
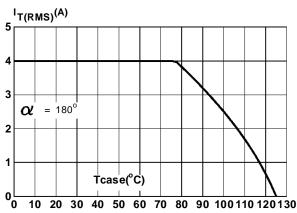


Fig.5: RMS on-state current versus case temperature (TO202-1).



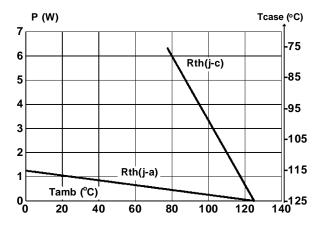


Fig.6: RMS on-state current versus case temperature (TO202-2).

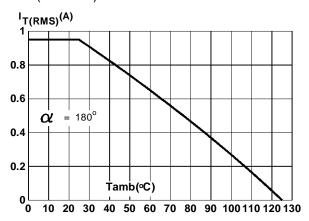


Fig.6: Relative variation of thermal impedance versus pulse duration (TO202-1).

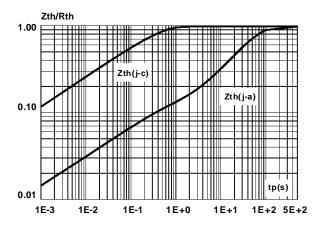


Fig.9: Relative variation of gate trigger current and holding current versus junction temperature.

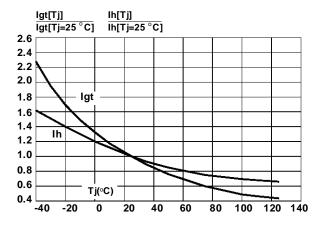


Fig.11: Non repetitive surge peak on-state current for a sinusoidal pulse with width: $tp \le 10ms$, and corresponding value of l^2t .

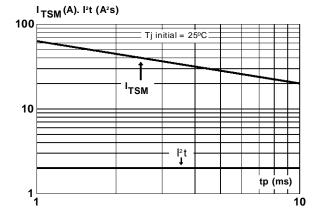


Fig.7: Relative variation of thermal impedance junction to ambient versus pulse duration (TO202-2).

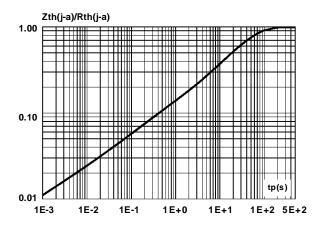


Fig.10: Non repetitive surge peak on-state current versus number of cycles.

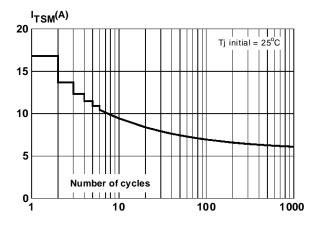
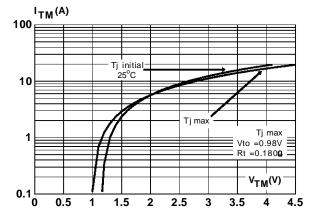
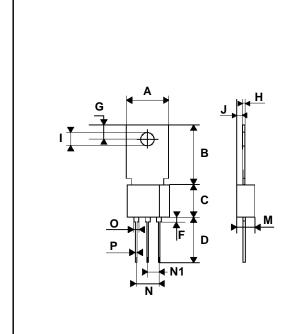


Fig.12: On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA TO202-1 (Plastic)

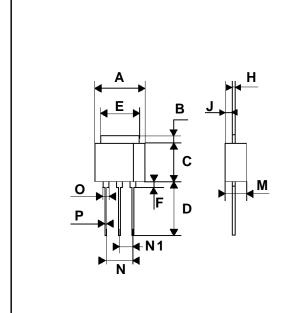


	DIMENSIONS						
REF.	Millimeters			Inches			
	Тур.	Min.	Max.	Тур.	Min.	Max.	
Α			10.1			0.398	
В	13.7			0.540			
С	7.3			0.287			
D	10.5			0.413			
F			1.5			0.059	
G	3.2			0.126			
Н	0.51			0.020			
I		3.16	3.20		0.124	0.126	
J	1.5			0.059			
М	4.5			0.177			
N			5.3			0.209	
N1	2.54	·		0.100			
0			1.4			0.055	
Р			0.7			0.028	

Marking: type number Weight: 1.4 g

PACKAGE MECHANICAL DATA

TO202-2 (Plastic)



	DIMENSIONS						
REF.	Millimeters			Inches			
	Тур.	Min.	Max.	Тур.	Min.	Max.	
Α			10.1			0.398	
В	1.2			0.047			
С	7.3			0.287			
D	10.5			0.413			
Е	7.4			0.290			
F			1.5			0.059	
Н	0.51			0.020			
J	1.5			0.059			
М	4.5			0.177			
N			5.3			0.209	
N1	2.54			0.100			
0	·	·	1.4			0.055	
Р			0.7			0.028	

Marking: type number

Weight: 1.0 g

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